



# SILEGO

# SLG59H1013V

## A 13.3 mΩ, 3.5 A, 125°C-Rated, Integrated Power Switch with 12V/24V Input Lockout Select and MOSFET Current Monitor Output

### General Description

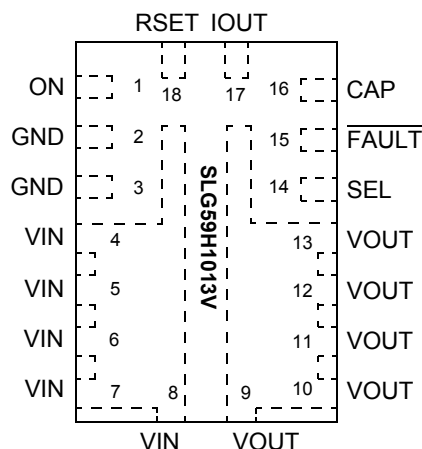
The SLG59H1013V is a high-performance 13.3 mΩ NMOS power switch designed to control 12 V or 24 V power rails up to 3.5 A. Using a proprietary MOSFET design, the SLG59H1013V achieves a stable 13.3 mΩ  $R_{DS(ON)}$  across a wide input/supply voltage range. Using Silego's proprietary CuFET™ technology, the SLG59H1013V package also exhibits a low thermal resistance for high-current operation.

Designed to operate over a -40°C to 125°C range, the SLG59H1013V is available in a low thermal resistance, RoHS-compliant, 1.6 x 3.0 mm STQFN package.

### Features

- Wide Operating Supply Voltage: 12 V or 24 V
- Maximum Continuous Switch Current: 3.5 A
- Automatic nFET SOA Protection
- High-performance MOSFET Switch
  - Low  $R_{DS(ON)}$ : 13.3 mΩ at  $V_{IN} = 24$  V
  - Low  $\Delta R_{DS(ON)}/\Delta V_{IN}$ : <0.05 mΩ/V
  - Low  $\Delta R_{DS(ON)}/\Delta T$ : <0.06 mΩ/°C
- Pin-programmable 12V/24V Input Overvoltage and Undervoltage Lockout
- Capacitor-programmable Inrush Current Control
- Two stage Current Limit Protection:
  - Resistor-programmable Active Current Limit
  - Internal Short-circuit Current limit
- Open Drain FAULT Signaling
- MOSFET Current Analog Output Monitor: 10 μA/A
- Fast 4 kΩ Output Discharge
- Pb-Free / Halogen-Free / RoHS Compliant Packaging

### Pin Configuration



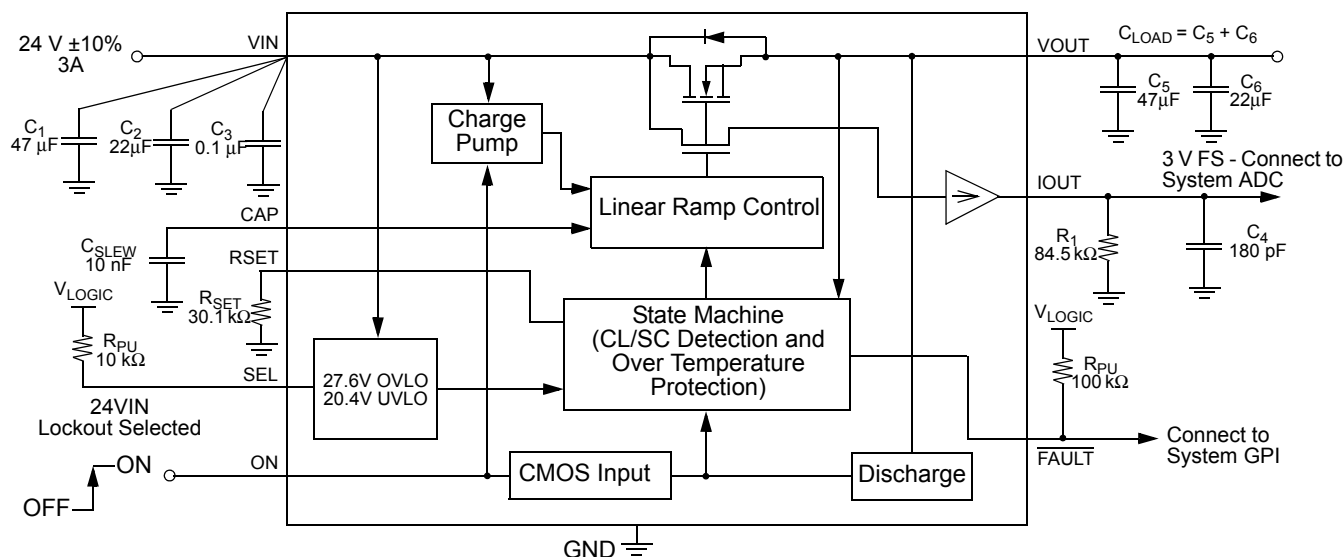
**18-pin STQFN**

1.6 x 3.0 mm, 0.40mm pitch  
(Top View)

### Applications

- Power-Rail Switching
- Multifunction Printers
- Large-format Copiers
- Telecommunications Equipment
- High-performance Computing
- 12 V and 24 V Point-of-Load Power Distribution
- Motor Drives

### Block Diagram and 3 A Typical Application Circuit





### Pin Description

| Pin # | Pin Name                  | Type   | Pin Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-------|---------------------------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1     | ON                        | Input  | A low-to-high transition on this pin initiates the operation of the SLG59H1013V's state machine. ON is an asserted HIGH, level-sensitive CMOS input with $V_{IL} < 0.3 \text{ V}$ and $V_{IH} > 0.9 \text{ V}$ . As the ON pin input circuit does not have an internal pull-down resistor, connect this pin to a general-purpose output (GPO) of a microcontroller, an application processor, or a system controller – do not allow this pin to be open-circuited.                                                                                                                                              |
| 2     | GND                       | GND    | Pin 2 is a low-current GND terminal for the SLG59H1013V. Connect directly to Pin 3                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 3     | GND                       | GND    | Pin 3 is the main ground connection for the SLG59H1013V's internal charge pump, its gate drive and current-limit circuits as well as its internal state machine. Therefore, use a short, stout connection from Pin 3 to the system's analog or power plane.                                                                                                                                                                                                                                                                                                                                                     |
| 4-8   | VIN                       | MOSFET | VIN supplies the power for the operation of the SLG59H1013V, its internal control circuitry, and the drain terminal of the nFET power switch. With 5 pins fused together at VIN, connect a 47 $\mu\text{F}$ (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VIN should be rated at 50 V or higher.                                                                                                                                                                                                                                                                                    |
| 9-13  | VOUT                      | MOSFET | Source terminal of n-channel MOSFET (5 pins fused for VOUT). Connect a 47 $\mu\text{F}$ (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VOUT should be rated at 50 V or higher.                                                                                                                                                                                                                                                                                                                                                                                                       |
| 14    | SEL                       | Input  | As a low logic-level CMOS input with $V_{IL} < 0.3 \text{ V}$ and $V_{IH} > 1.65 \text{ V}$ , SEL selects one of two undervoltage/overvoltage lockout windows. When SEL = LOW, the $V_{IN}$ undervoltage/overvoltage lockout window is set for $12 \text{ V} \pm 10\%$ applications. When SEL = HIGH, the $V_{IN}$ undervoltage/overvoltage lockout window is set for $24 \text{ V} \pm 10\%$ applications. See the Electrical Characteristics table for additional information.                                                                                                                                |
| 15    | $\overline{\text{FAULT}}$ | Output | An open drain output, FAULT is asserted within $T_{\text{FAULT\_LOW}}$ when a $V_{IN}$ undervoltage, $V_{IN}$ overvoltage, a current-limit, a nFET SOA, or an over-temperature condition is detected. $\overline{\text{FAULT}}$ is deasserted within $T_{\text{FAULT\_HIGH}}$ when the fault condition is removed. Connect a 100 k $\Omega$ external resistor from the $\overline{\text{FAULT}}$ pin to local system logic supply.                                                                                                                                                                              |
| 16    | CAP                       | Output | A low-ESR, stable dielectric, ceramic surface-mount capacitor connected from CAP pin to GND sets the $V_{\text{OUT}}$ slew rate and overall turn-on time of the SLG59H1013V. For best performance, the range for $C_{\text{SLEW}}$ values are $10 \text{ nF} \leq C_{\text{SLEW}} \leq 20 \text{ nF}$ – please see typical characteristics for additional information. Capacitors used at the CAP pin should be rated at 10 V or higher. See equation for selecting capacitor and start-up slewing.                                                                                                             |
| 17    | IOUT                      | Output | IOUT is the SLG59H1013V's power MOSFET load current monitor output. As an analog output current, this signal when applied to a ground-reference resistor generates a voltage proportional to the current through the n-channel MOSFET. The $I_{\text{OUT}}$ transfer characteristic is typically 10 $\mu\text{A/A}$ with a voltage compliance range of $0.5 \text{ V} \leq V_{\text{IOUT}} \leq 4 \text{ V}$ . Optimal $I_{\text{OUT}}$ linearity is exhibited for $0.5 \text{ A} \leq I_{\text{DS}} \leq 4 \text{ A}$ . In addition, it is recommended to bypass the IOUT pin to GND with a 0.18 nF capacitor. |
| 18    | RSET                      | Input  | A 1%-tolerance, metal-film resistor between 23.7 k $\Omega$ and 91 k $\Omega$ sets the SLG59H1013V's active current limit. A 91 k $\Omega$ resistor sets the SLG59H1013V's active current limit to 1 A and a 23.7 k $\Omega$ resistor sets the active current limit to 4 A.                                                                                                                                                                                                                                                                                                                                     |

### Ordering Information

| Part Number   | Type                         | Production Flow                       |
|---------------|------------------------------|---------------------------------------|
| SLG59H1013V   | STQFN 18L FC                 | Extended Industrial, -40 °C to 125 °C |
| SLG59H1013VTR | STQFN 18L FC (Tape and Reel) | Extended Industrial, -40 °C to 125 °C |



### Absolute Maximum Ratings

| Parameter                                  | Description                                             | Conditions                                                                                                              | Min. | Typ. | Max.     | Unit |
|--------------------------------------------|---------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|------|------|----------|------|
| $V_{IN}$ to GND                            | Power Switch Input Voltage to GND                       | Continuous                                                                                                              | -0.3 | --   | 30       | V    |
|                                            |                                                         | Maximum pulsed $V_{IN}$ , pulse width < 0.1s                                                                            | --   | --   | 32       | V    |
| $V_{OUT}$ to GND                           | Power Switch Output Voltage to GND                      |                                                                                                                         | -0.3 | --   | $V_{IN}$ | V    |
| ON, SEL, CAP, RSET, IOUT, and FAULT to GND | ON, SEL, CAP, RSET, IOUT, and FAULT Pin Voltages to GND |                                                                                                                         | -0.3 | --   | 7        | V    |
| $T_S$                                      | Storage Temperature                                     |                                                                                                                         | -65  | --   | 150      | °C   |
| ESD <sub>HBM</sub>                         | ESD Protection                                          | Human Body Model                                                                                                        | 2000 | --   | --       | V    |
| ESD <sub>CDM</sub>                         | ESD Protection                                          | Charged Device Model                                                                                                    | 500  | --   | --       | V    |
| MSL                                        | Moisture Sensitivity Level                              |                                                                                                                         | 1    |      |          |      |
| $\theta_{JA}$                              | Thermal Resistance                                      | 1.6 x 3.0 mm 18L STQFN; Determined with the device mounted onto a 1 in <sup>2</sup> , 1 oz. copper pad of FR-4 material | --   | 40   | --       | °C/W |
| MOSFET IDS <sub>CONT</sub>                 | Continuous Current from $V_{IN}$ to $V_{OUT}$           | $T_J < 150^\circ\text{C}$                                                                                               | --   | --   | 4        | A    |
| MOSFET IDS <sub>PEAK</sub>                 | Peak Current from $V_{IN}$ to $V_{OUT}$                 | Maximum pulsed switch current, pulse width < 1 ms                                                                       | --   | --   | 6        | A    |

Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### Electrical Characteristics

12 V ≤  $V_{IN}$  ≤ 24 V;  $C_{IN}$  = 47 μF,  $T_A$  = -40°C to 125°C, unless otherwise noted. Typical values are at  $T_A$  = 25°C

| Parameter         | Description                             | Conditions                                      | Min. | Typ. | Max. | Unit |
|-------------------|-----------------------------------------|-------------------------------------------------|------|------|------|------|
| $V_{IN}$          | Operating Input Voltage                 |                                                 | 10.8 | --   | 26.4 | V    |
| $V_{IN(OVLO)}$    | $V_{IN}$ Overvoltage Lockout Threshold  | $V_{IN} \uparrow$ ; SEL = HIGH                  | 26.5 | 27   | 28.5 | V    |
|                   |                                         | $V_{IN} \uparrow$ ; SEL = LOW                   | 13.3 | 13.7 | 14.5 | V    |
| $V_{IN(UVLO)}$    | $V_{IN}$ Undervoltage Lockout Threshold | $V_{IN} \downarrow$ ; SEL = HIGH                | 19.5 | 20.5 | 21.5 | V    |
|                   |                                         | $V_{IN} \downarrow$ ; SEL = LOW                 | 9.7  | 10.2 | 10.7 | V    |
| $I_Q$             | Quiescent Supply Current                | ON = HIGH;<br>$I_{DS} = 0$ A                    | --   | 0.5  | 0.6  | mA   |
| $I_{SHDN}$        | OFF Mode Supply Current                 | ON = LOW;<br>$I_{DS} = 0$ A                     | --   | 1    | 13   | μA   |
| RDS <sub>ON</sub> | Static Drain to Source ON Resistance    | $T_A = 25^\circ\text{C}$ ;<br>$I_{DS} = 0.1$ A  | --   | 13.3 | 14   | mΩ   |
|                   |                                         | $T_A = 85^\circ\text{C}$ ;<br>$I_{DS} = 0.1$ A  | --   | 17   | 18.5 | mΩ   |
|                   |                                         | $T_A = 125^\circ\text{C}$ ;<br>$I_{DS} = 0.1$ A | --   | 20   | 21.5 | mΩ   |
| $I_{LIMIT}$       | Active Current Limit, $I_{ACL}$         | $V_{OUT} > 0.5$ V; $R_{SET} = 30.1$ kΩ          | 3.0  | 3.19 | 3.5  | A    |
|                   | Short-circuit Current Limit, $I_{SCL}$  | $V_{OUT} < 0.5$ V                               | --   | 0.5  | -    | A    |
| $T_{ACL}$         | Active Current Limit Response Time      | $R_{SET} = 51.6$ kΩ                             | --   | 120  | --   | μs   |



### Electrical Characteristics (continued)

12 V ≤ V<sub>IN</sub> ≤ 24 V; C<sub>IN</sub> = 47 μF, T<sub>A</sub> = -40°C to 125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = 25°C

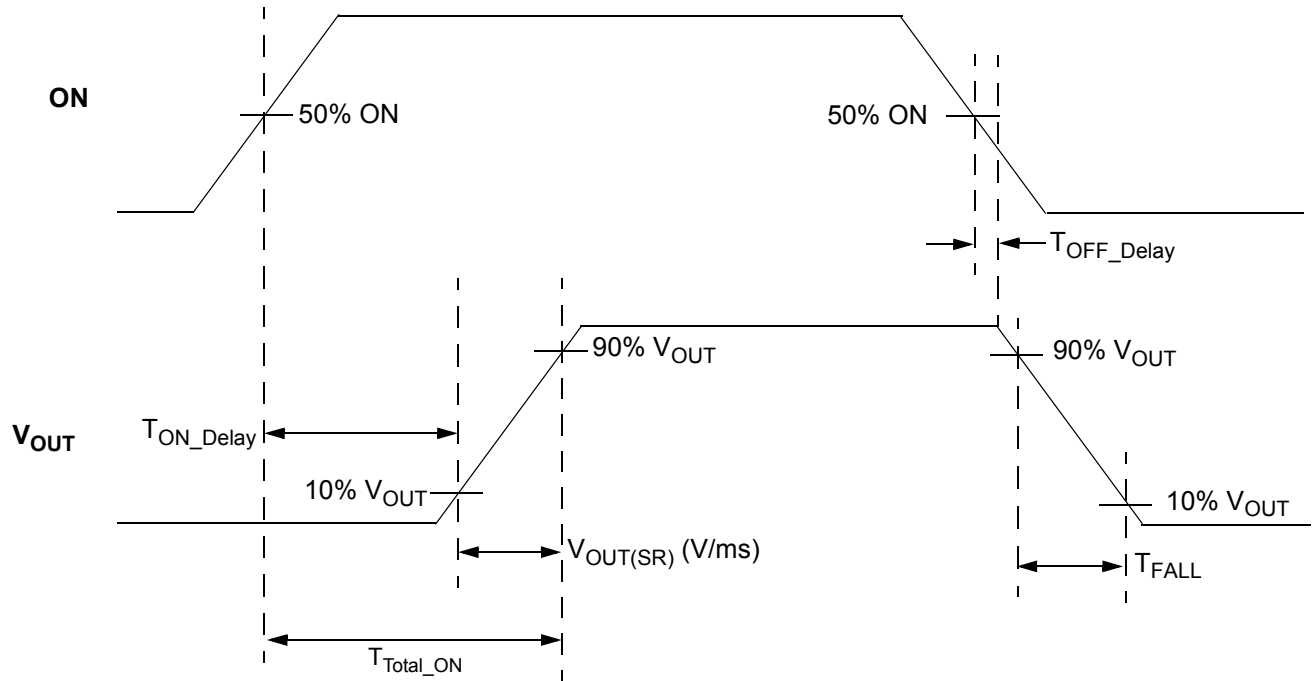
| Parameter                | Description                                                     | Conditions                                                                                                                                                            | Min.                                           | Typ. | Max. | Unit |
|--------------------------|-----------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|------|------|------|
| R <sub>DSCHRG</sub>      | Output Discharge Resistance                                     |                                                                                                                                                                       | 3.5                                            | 4.4  | 5.3  | kΩ   |
| I <sub>OUT</sub>         | MOSFET Current Analog Monitor Output                            | I <sub>LOAD</sub> = 1 A                                                                                                                                               | 9.3                                            | 10   | 10.7 | μA   |
|                          |                                                                 | I <sub>LOAD</sub> = 3 A                                                                                                                                               | 28.5                                           | 30   | 31.5 | μA   |
| T <sub>IOUT</sub>        | I <sub>OUT</sub> Response Time to Change in Main MOSFET Current | C <sub>IOUT</sub> = 180 pF;<br>Step load 0 to 2.4 A; 0% to 90% I <sub>OUT</sub>                                                                                       | --                                             | 45   | --   | μs   |
| C <sub>LOAD</sub>        | Output Load Capacitance                                         | C <sub>LOAD</sub> connected from V <sub>OUT</sub> to GND                                                                                                              | 47                                             | --   | --   | μF   |
| T <sub>ON_Delay</sub>    | ON Delay Time                                                   | 50% ON to 10% V <sub>OUT</sub> ↑;<br>V <sub>IN</sub> = 12 V; C <sub>SLEW</sub> = 10 nF;<br>R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF                       | 480                                            | 600  | 720  | μs   |
|                          |                                                                 | 50% ON to 10% V <sub>OUT</sub> ↑;<br>V <sub>IN</sub> = 24 V; C <sub>SLEW</sub> = 10 nF;<br>R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF                       | 0.8                                            | 1.0  | 1.2  | ms   |
| T <sub>Total_ON</sub>    | Total Turn-on Time                                              | 50% ON to 90% V <sub>OUT</sub> ↑                                                                                                                                      | Set by External C <sub>SLEW</sub> <sup>1</sup> |      |      | ms   |
|                          |                                                                 | 50% ON to 90% V <sub>OUT</sub> ↑;<br>V <sub>IN</sub> = 12 V; C <sub>SLEW</sub> = 10 nF;<br>R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF                       | 2.9                                            | 3.6  | 4.3  | ms   |
|                          |                                                                 | 50% ON to 90% V <sub>OUT</sub> ↑;<br>V <sub>IN</sub> = 24 V; C <sub>SLEW</sub> = 10 nF;<br>R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF                       | 5.7                                            | 7.1  | 8.5  | ms   |
| V <sub>OUT(SR)</sub>     | VOUT Slew rate                                                  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> ↑                                                                                                                        | Set by External C <sub>SLEW</sub> <sup>1</sup> |      |      | V/ms |
|                          |                                                                 | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> ↑;<br>V <sub>IN</sub> = 12 V or 24 V; C <sub>SLEW</sub> = 10 nF;<br>R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF | 2.7                                            | 3.2  | 3.9  | V/ms |
| T <sub>OFF_Delay</sub>   | OFF Delay Time                                                  | 50% ON to V <sub>OUT</sub> ↓;<br>R <sub>LOAD</sub> = 100 Ω, No C <sub>LOAD</sub>                                                                                      | --                                             | 15   | --   | μs   |
| T <sub>Fall</sub>        | VOUT Fall Time                                                  | ON = HIGH-to-LOW;<br>R <sub>LOAD</sub> = 100 Ω, No C <sub>LOAD</sub>                                                                                                  | 10.4                                           | 12.7 | 14.3 | μs   |
| T <sub>FAULT_LOW</sub>   | FAULT Assertion Time                                            | Abnormal Step Load Current even to to FAULT ↓;<br>I <sub>ACL</sub> = 1 A; V <sub>IN</sub> = 24 V; R <sub>SET</sub> = 90 kΩ;<br>switch in 20 Ω load                    | --                                             | 80   | --   | μs   |
| T <sub>FAULT_HIGH</sub>  | FAULT De-assertion Time                                         | Delay to FAULT ↑ after fault condition is removed; I <sub>ACL</sub> = 1 A; V <sub>IN</sub> = 24 V;<br>R <sub>SET</sub> = 90 kΩ; switch out 20 Ω load                  | --                                             | 180  | --   | μs   |
| FAULT <sub>VOL</sub>     | FAULT Output Low Voltage                                        | I <sub>FAULT</sub> = 1 mA                                                                                                                                             | --                                             | 0.2  | --   | V    |
| ON_VIH                   | ON Pin Input High Voltage                                       |                                                                                                                                                                       | 0.9                                            | --   | 5    | V    |
| ON_VIL                   | ON Pin Input Low Voltage                                        |                                                                                                                                                                       | -0.3                                           | 0    | 0.3  | V    |
| SEL_VIH                  | SEL pin Input High Voltage                                      |                                                                                                                                                                       | 1.65                                           | --   | 4.5  | V    |
| SEL_VIL                  | SEL pin Input Low Voltage                                       |                                                                                                                                                                       | -0.3                                           | --   | 0.3  | V    |
| I <sub>ON(Leakage)</sub> | ON Pin Leakage Current                                          | 1 V ≤ ON ≤ 5 V or ON = GND                                                                                                                                            | --                                             | --   | 1    | μA   |
| THERM <sub>ON</sub>      | Thermal Protection Shutdown Threshold                           |                                                                                                                                                                       | --                                             | 150  | --   | °C   |
| THERM <sub>OFF</sub>     | Thermal Protection Restart Threshold                            |                                                                                                                                                                       | --                                             | 125  | --   | °C   |

Notes:

1. Refer to typical Timing Parameter vs. C<sub>SLEW</sub> performance charts for additional information.



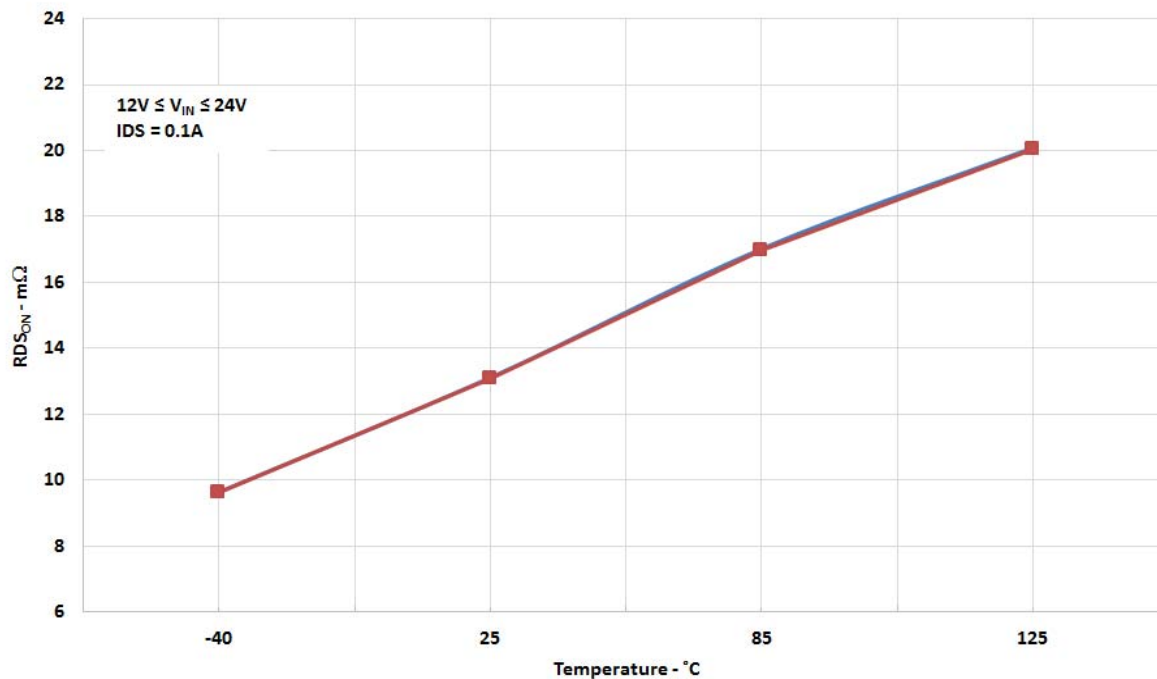
### $T_{Total\_ON}$ , $T_{ON\_Delay}$ and Slew Rate Measurement Timing Details



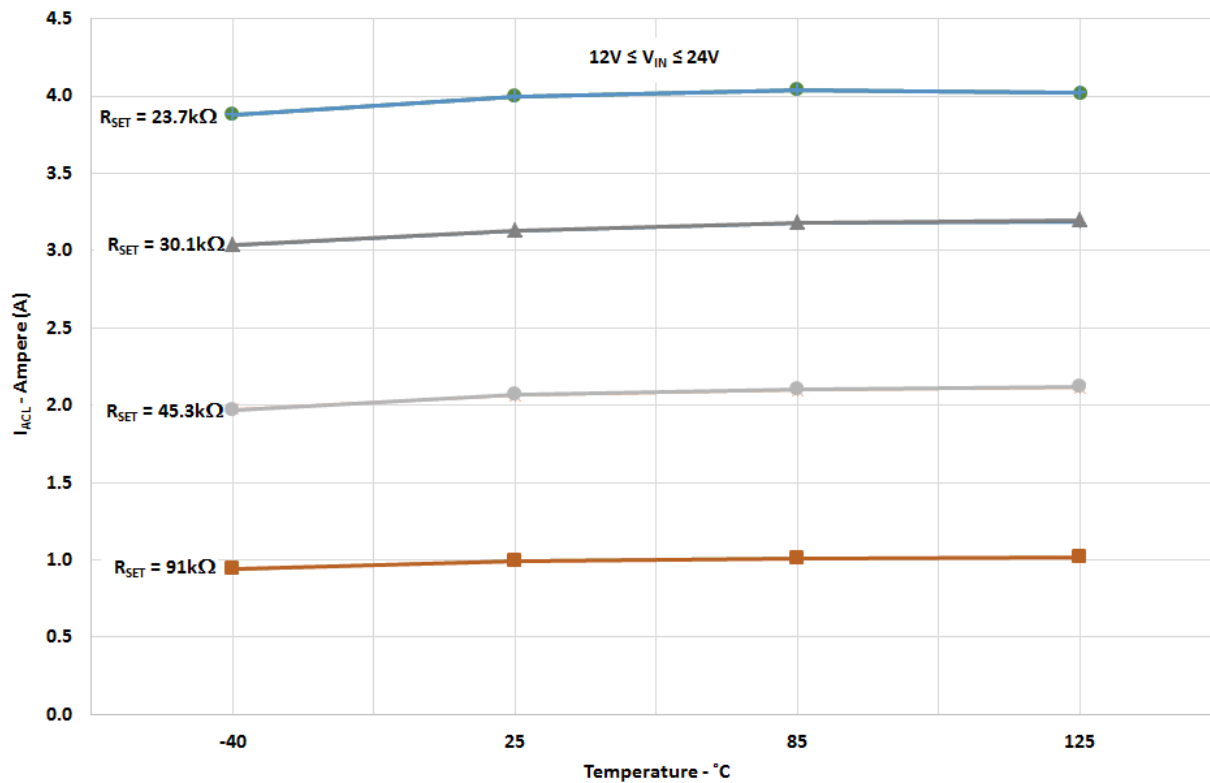


### Typical Performance Characteristics

#### $R_{DS_{ON}}$ vs. Temperature and $V_{IN}$

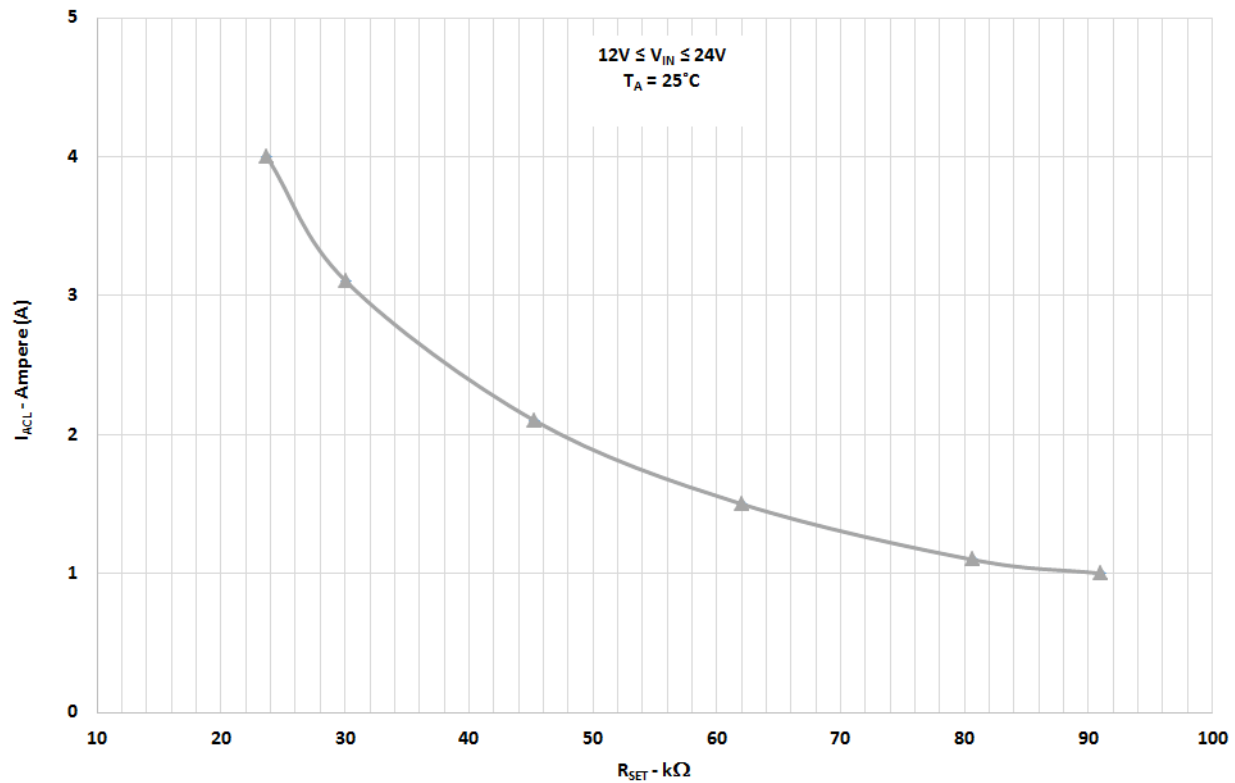


#### $I_{ACL}$ vs. Temperature and $R_{SET}$

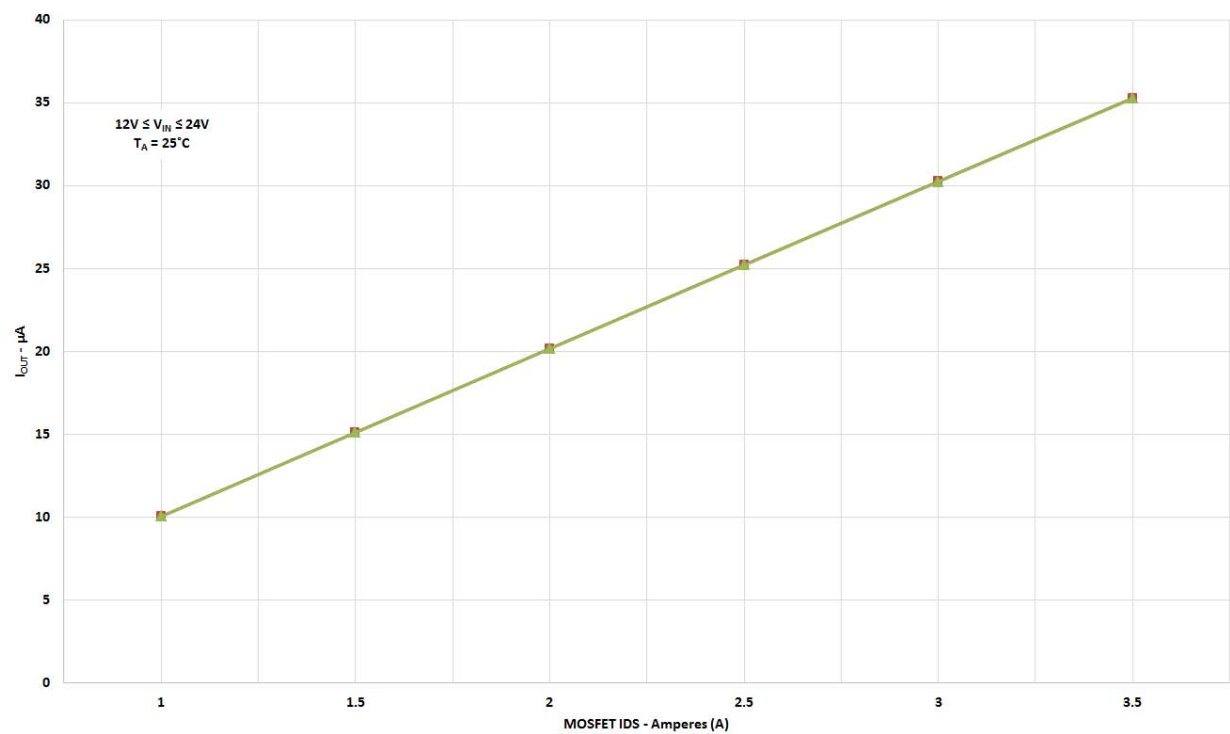




### $I_{ACL}$ vs. $R_{SET}$ and Temperature

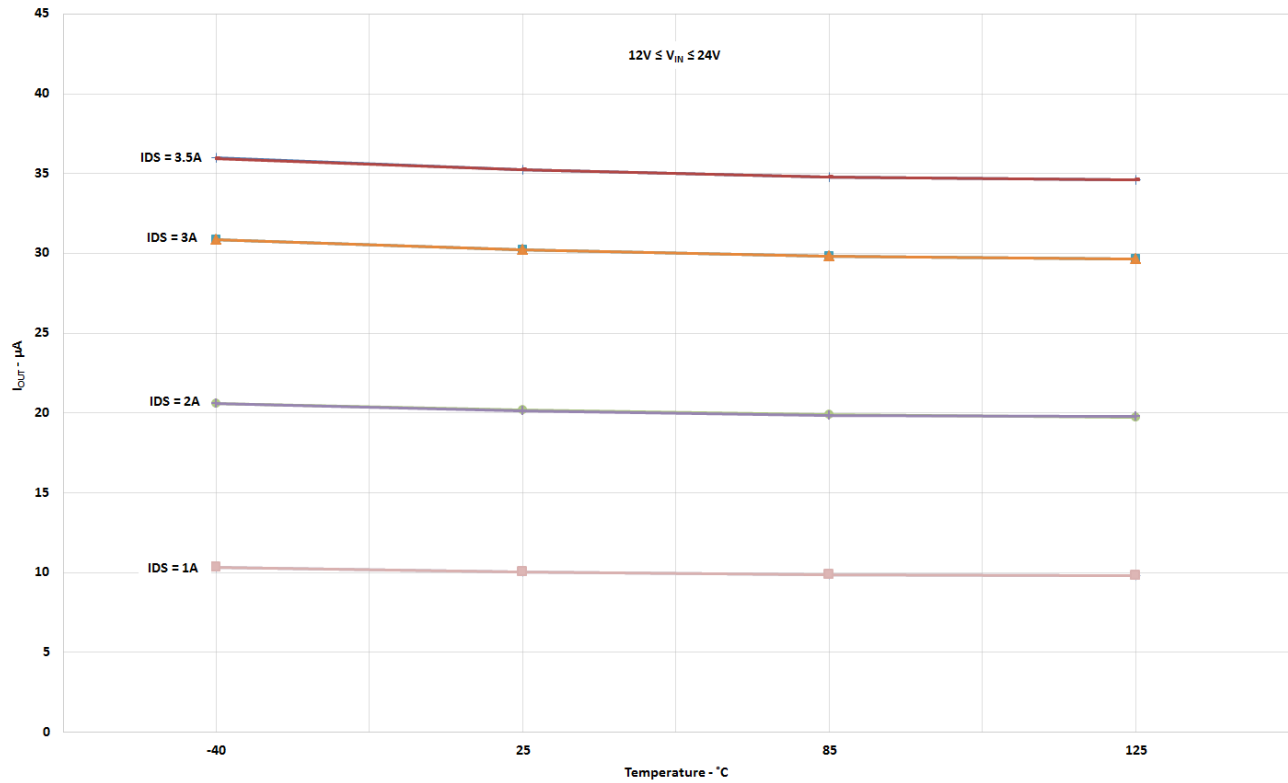


### $I_{OUT}$ vs. MOSFET $I_{DS}$ and $V_{IN}$

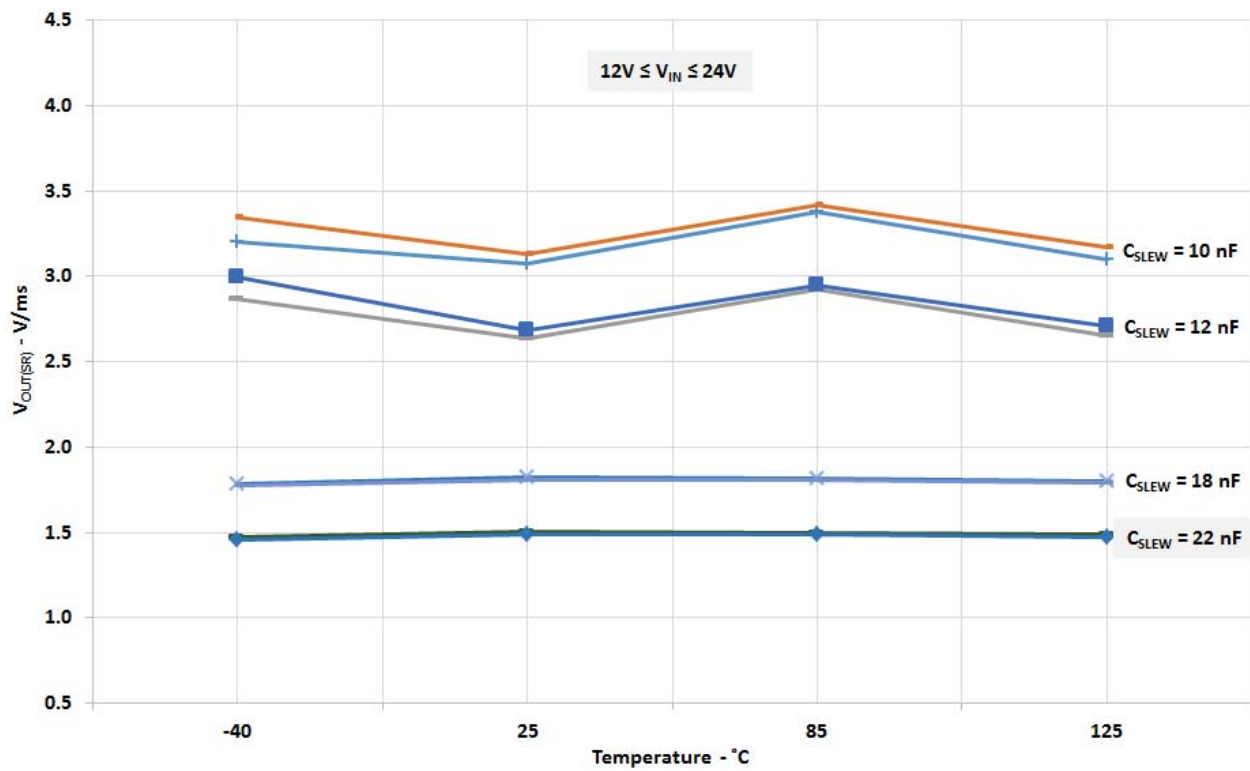




### $I_{OUT}$ vs. Temperature and MOSFET $I_{DS}$

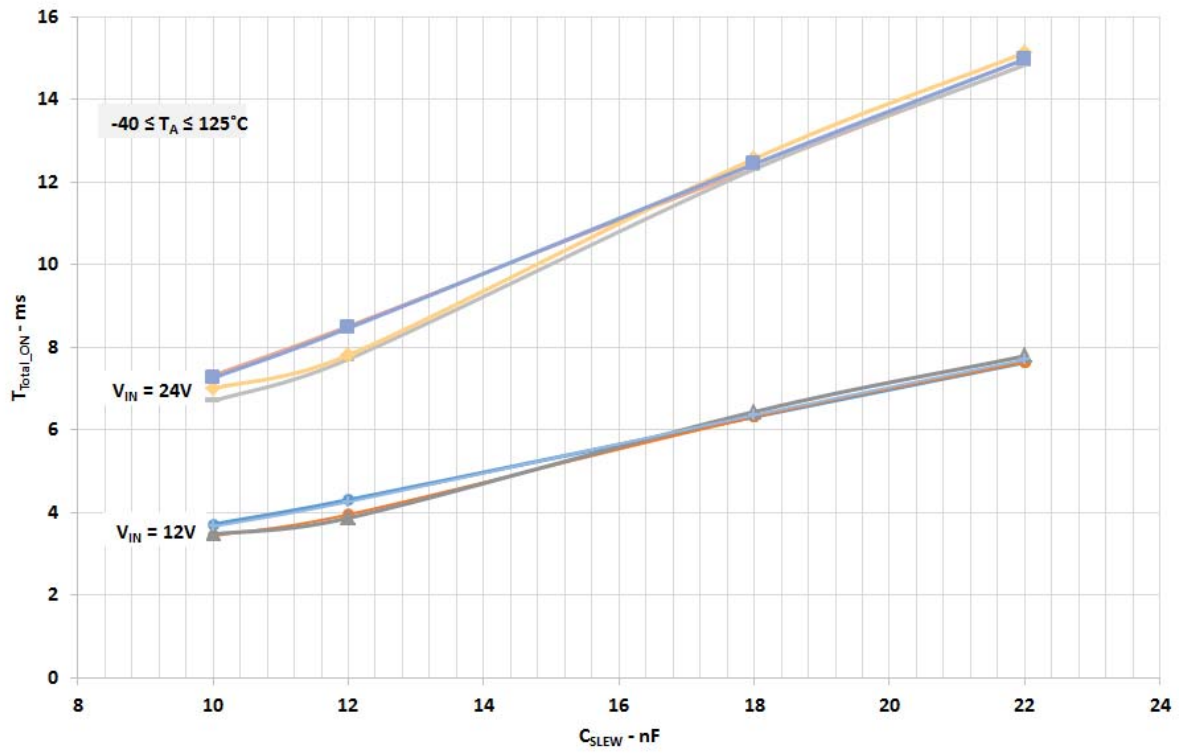


### $V_{OUT}$ Slew Rate vs. Temperature, $V_{IN}$ , and $C_{SLEW}$





$T_{\text{Total ON}}$  vs.  $C_{\text{SLEW}}$ ,  $V_{\text{IN}}$ , and Temperature





### Typical Turn-on Waveforms - $V_{IN} = 12\text{ V}$

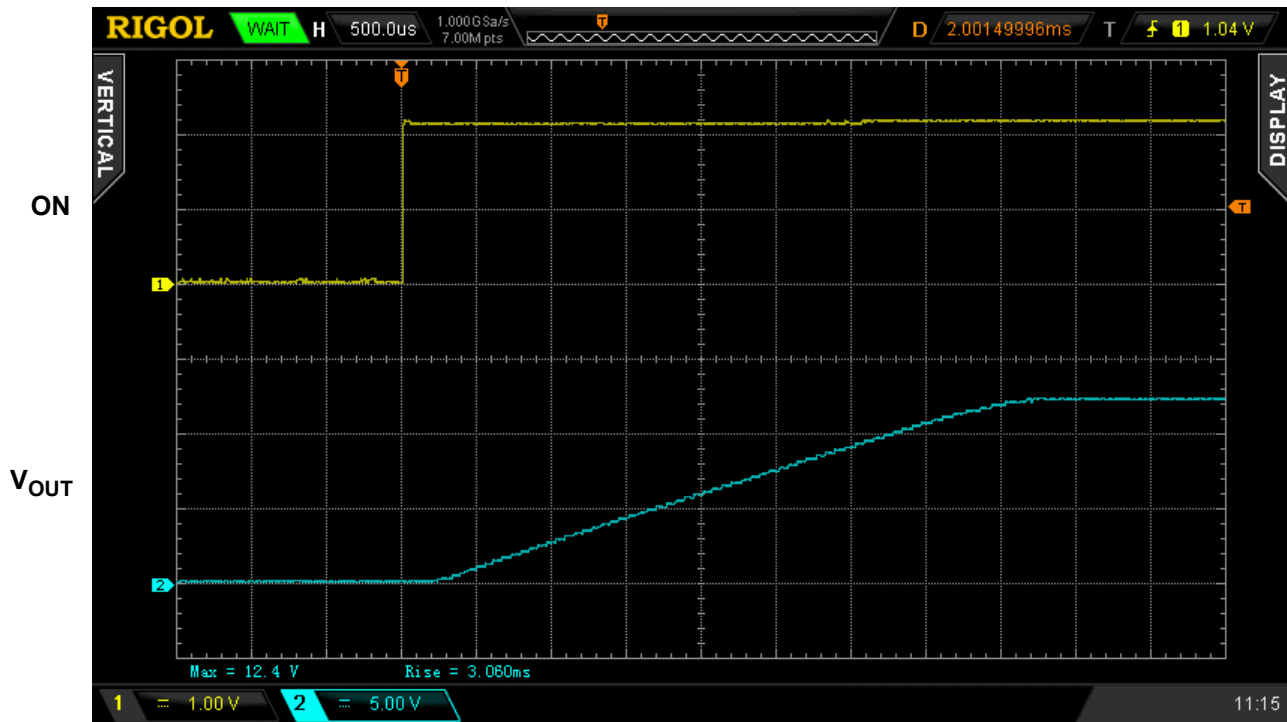


Figure 1. Typical Turn ON operation waveform for  $V_{IN} = 12\text{ V}$ ,  $C_{SLEW} = 10\text{ nF}$ ,  $C_{LOAD} = 10\text{ }\mu\text{F}$ ,  $R_{LOAD} = 100\text{ }\Omega$

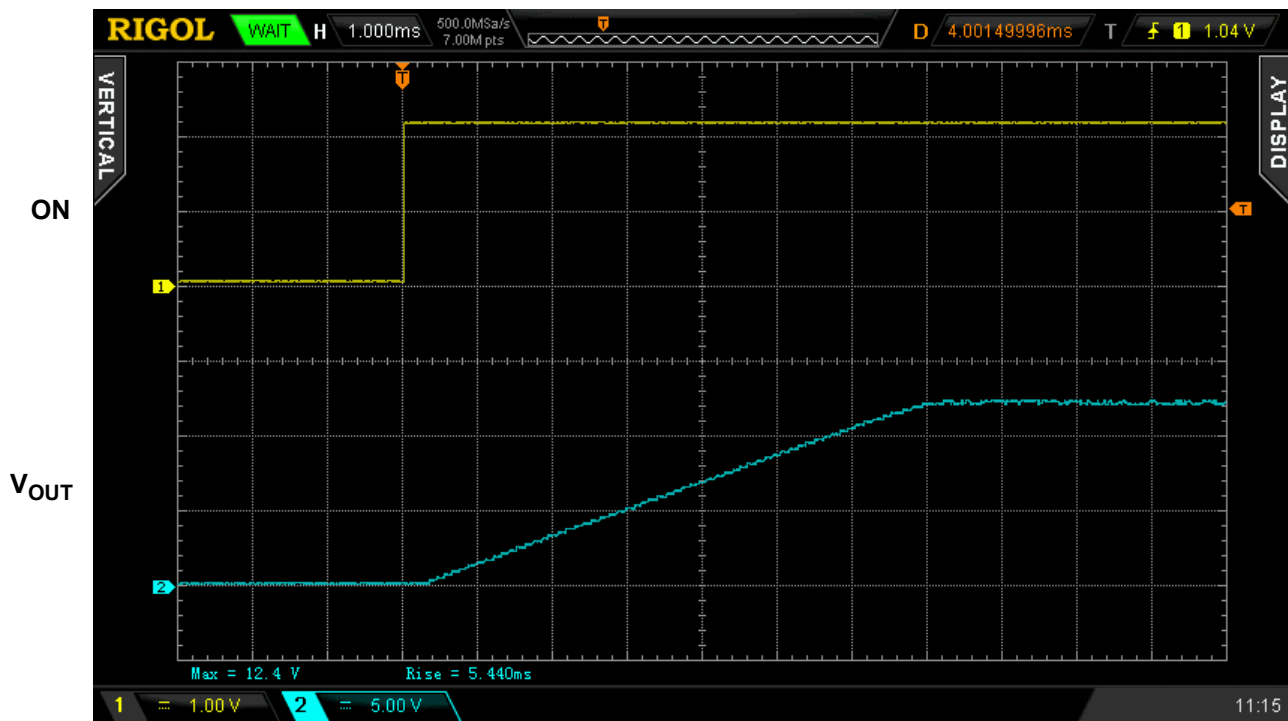


Figure 2. Typical Turn ON operation waveform for  $V_{IN} = 12\text{ V}$ ,  $C_{SLEW} = 18\text{ nF}$ ,  $C_{LOAD} = 10\text{ }\mu\text{F}$ ,  $R_{LOAD} = 100\text{ }\Omega$



### Typical Turn-on Waveforms - $V_{IN} = 24\text{ V}$

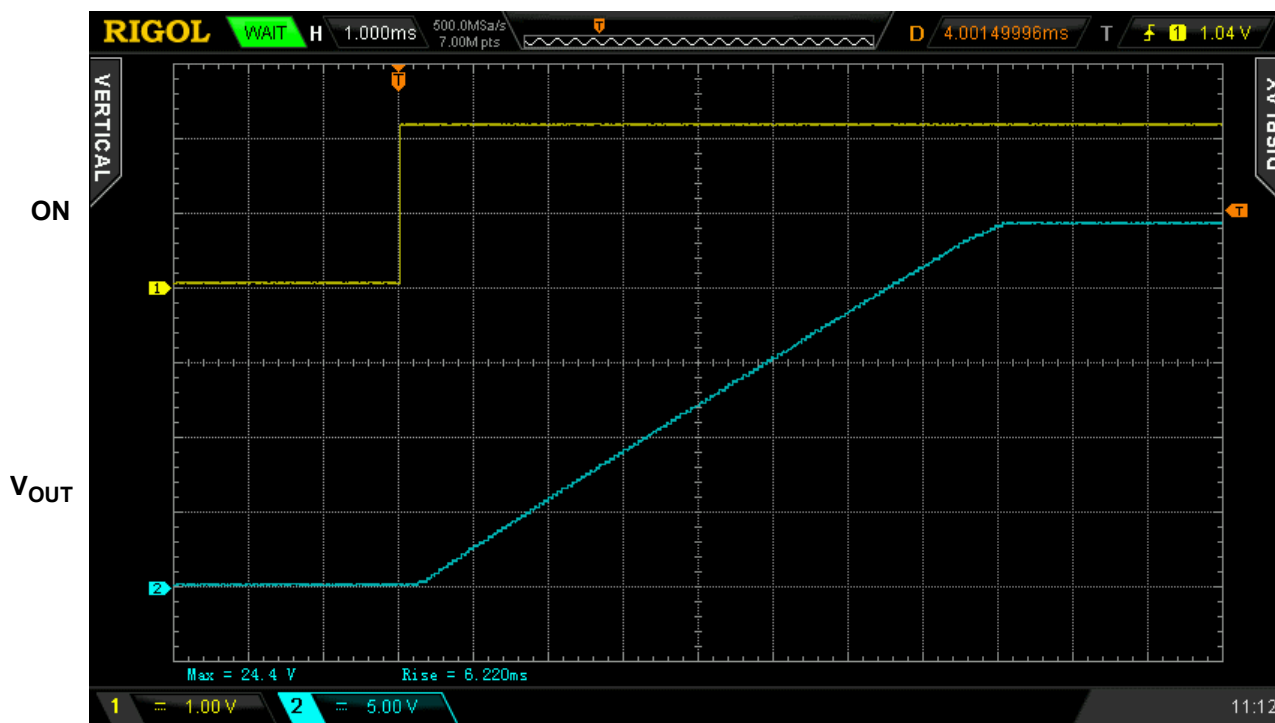


Figure 3. Typical Turn ON operation waveform for  $V_{IN} = 24\text{ V}$ ,  $C_{SLEW} = 10\text{ nF}$ ,  $C_{LOAD} = 10\text{ }\mu\text{F}$ ,  $R_{LOAD} = 100\text{ }\Omega$

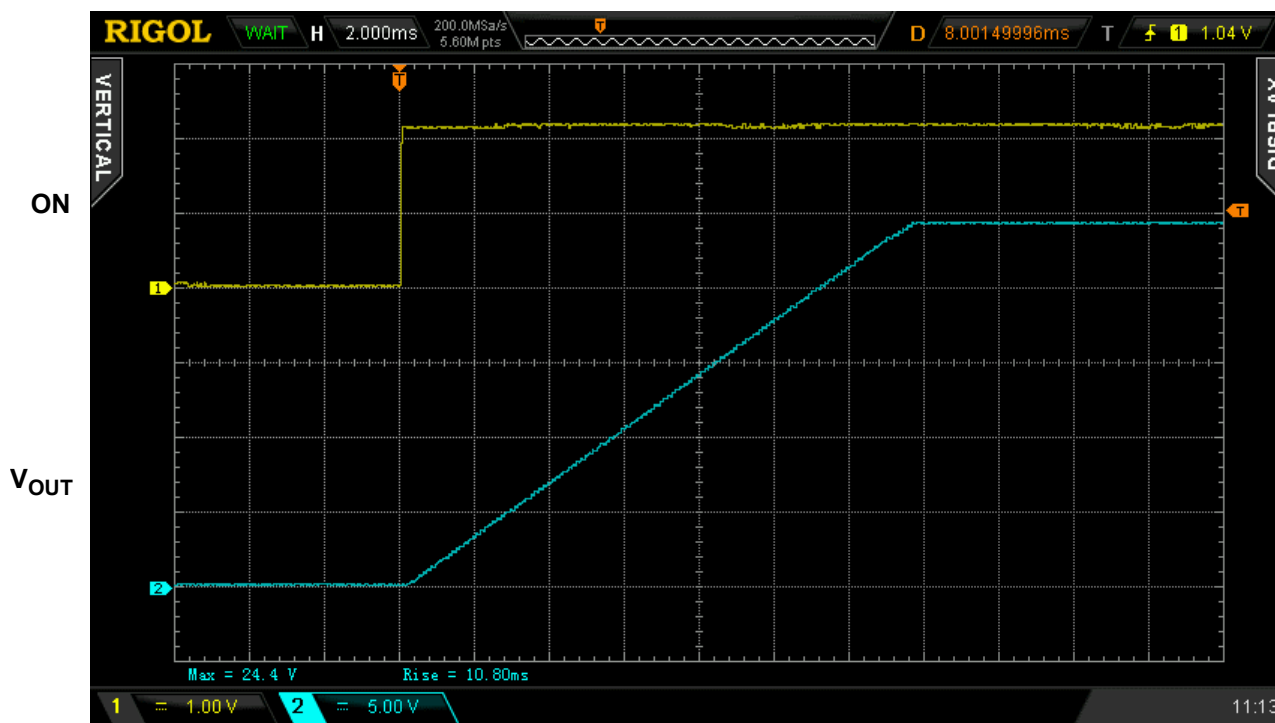


Figure 4. Typical Turn ON operation waveform for  $V_{IN} = 24\text{ V}$ ,  $C_{SLEW} = 18\text{ nF}$ ,  $C_{LOAD} = 10\text{ }\mu\text{F}$ ,  $R_{LOAD} = 100\text{ }\Omega$



### Typical Turn-off Waveforms - $V_{IN} = 12\text{ V}$

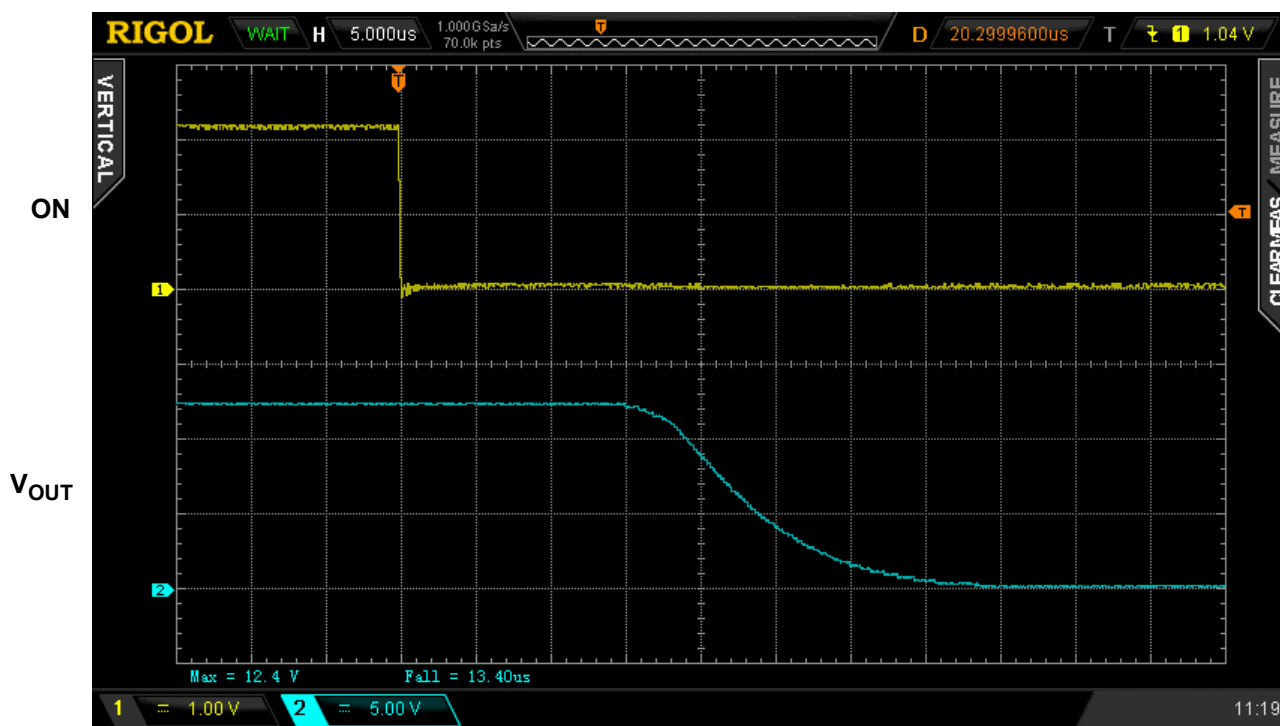


Figure 5. Typical Turn OFF operation waveform for  $V_{IN} = 12\text{ V}$ ,  $C_{SLEW} = 10\text{ nF}$ , no  $C_{LOAD}$ ,  $R_{LOAD} = 100\text{ }\Omega$

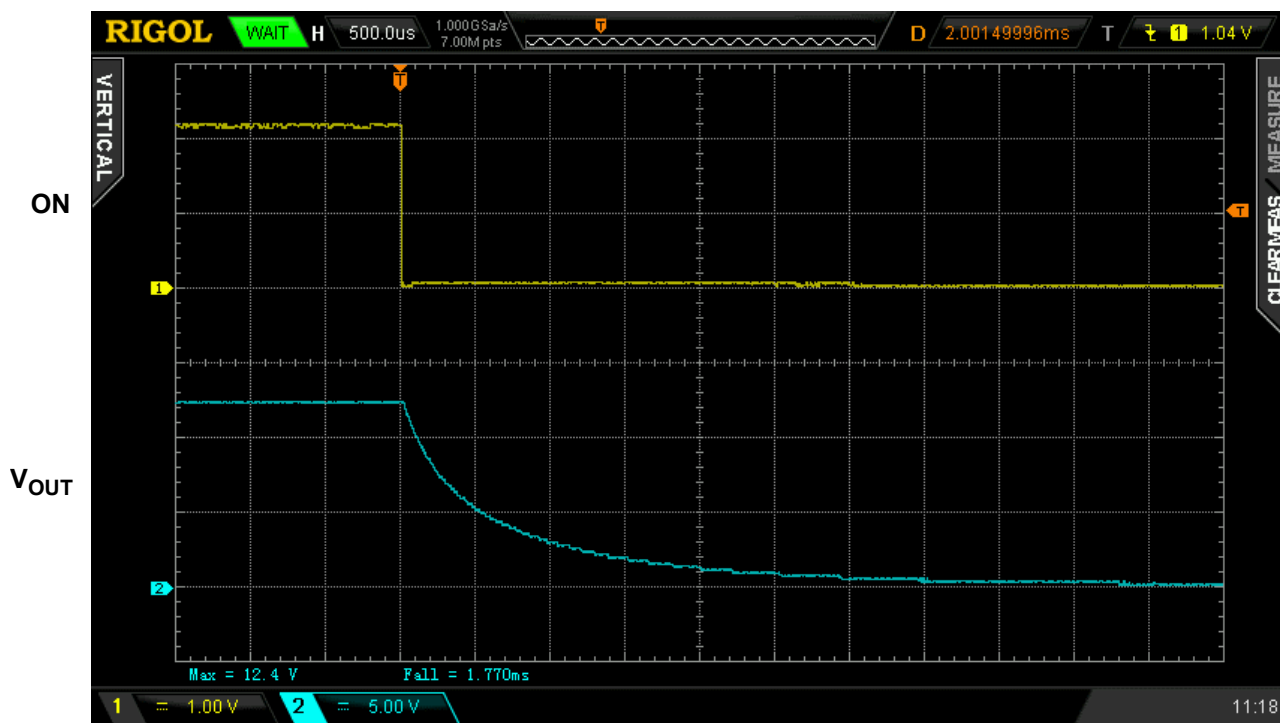


Figure 6. Typical Turn OFF operation waveform for  $V_{IN} = 12\text{ V}$ ,  $C_{SLEW} = 10\text{ nF}$ ,  $C_{LOAD} = 10\text{ }\mu\text{F}$ ,  $R_{LOAD} = 100\text{ }\Omega$



### Typical Turn-off Waveforms - $V_{IN} = 24\text{ V}$

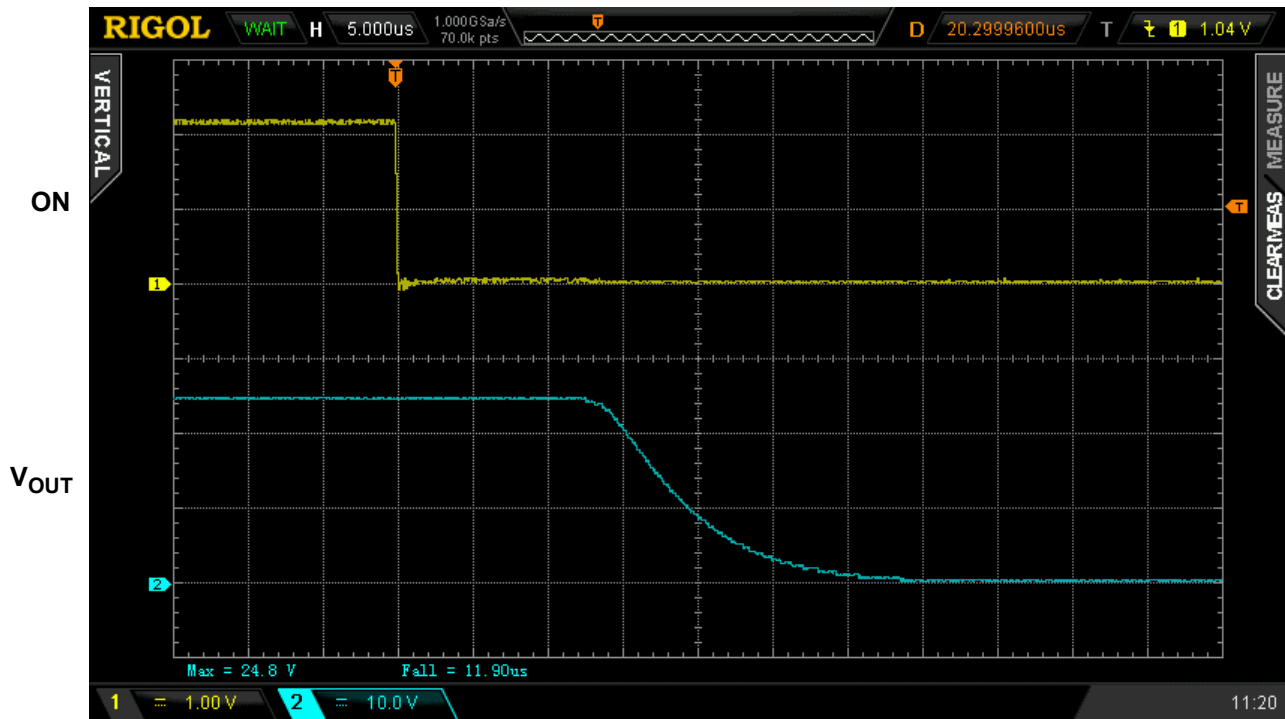


Figure 7. Typical Turn OFF operation waveform for  $V_{IN} = 24\text{ V}$ ,  $C_{SLEW} = 10\text{ nF}$ , no  $C_{LOAD}$ ,  $R_{LOAD} = 100\text{ }\Omega$

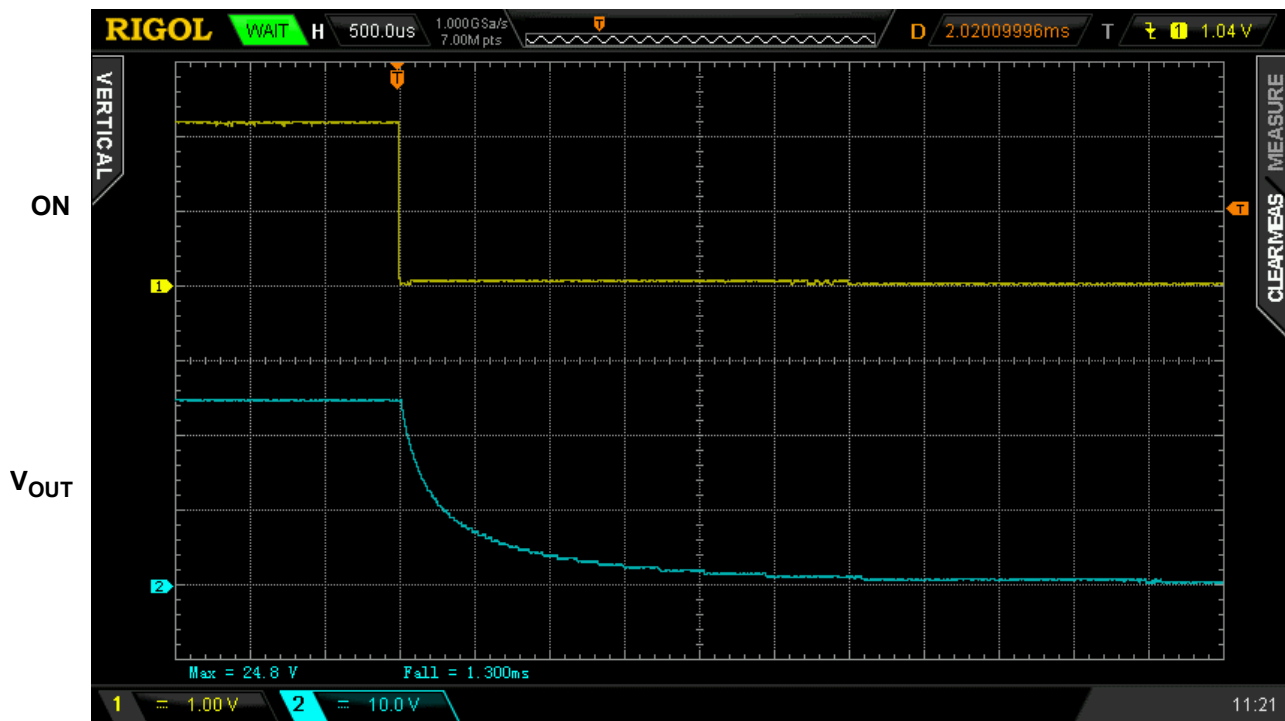
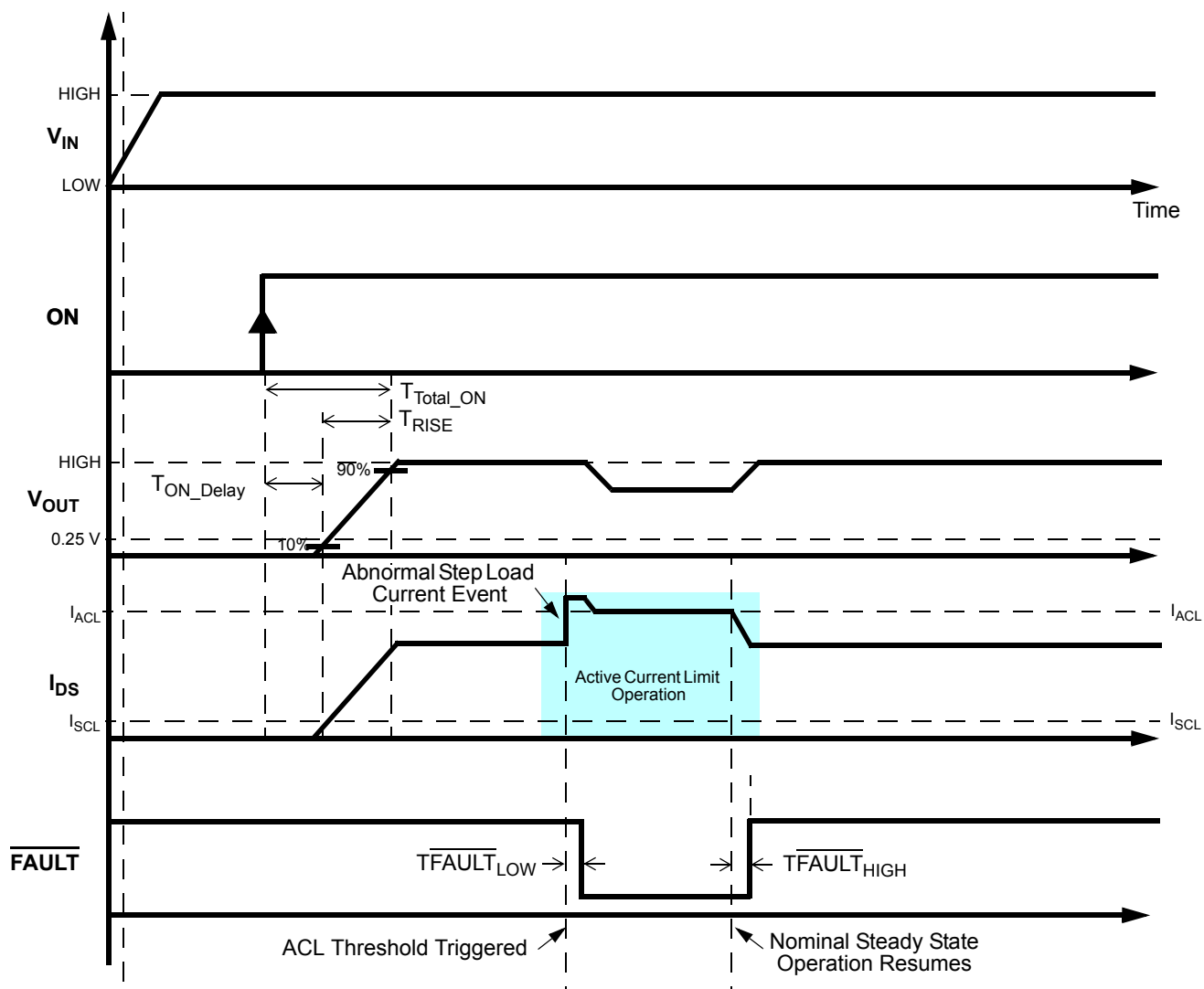


Figure 8. Typical Turn OFF operation waveform for  $V_{IN} = 24\text{ V}$ ,  $C_{SLEW} = 10\text{ nF}$ ,  $C_{LOAD} = 10\text{ }\mu\text{F}$ ,  $R_{LOAD} = 100\text{ }\Omega$

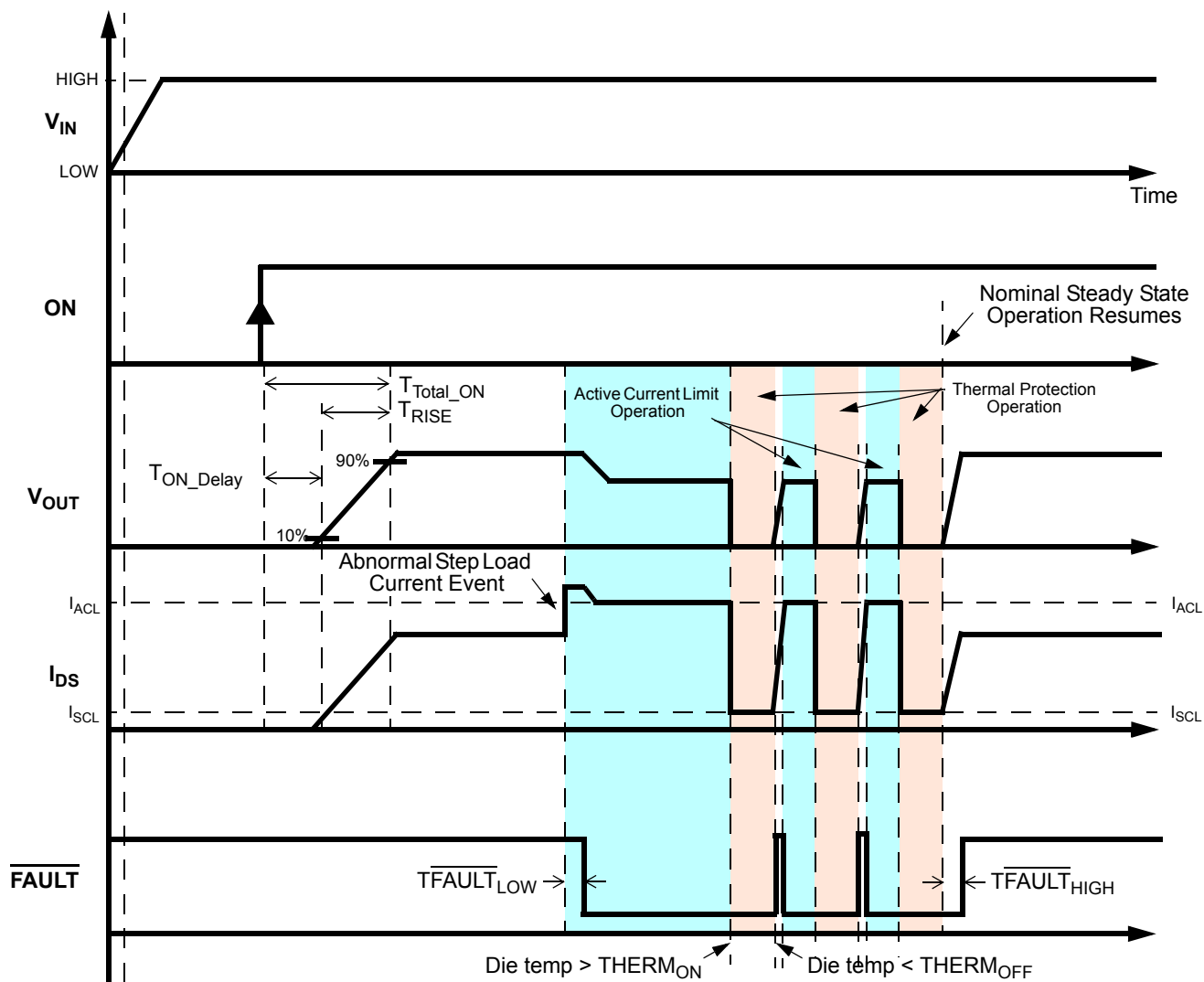


### Timing Diagram - Basic Operation including Active Current Limit Protection



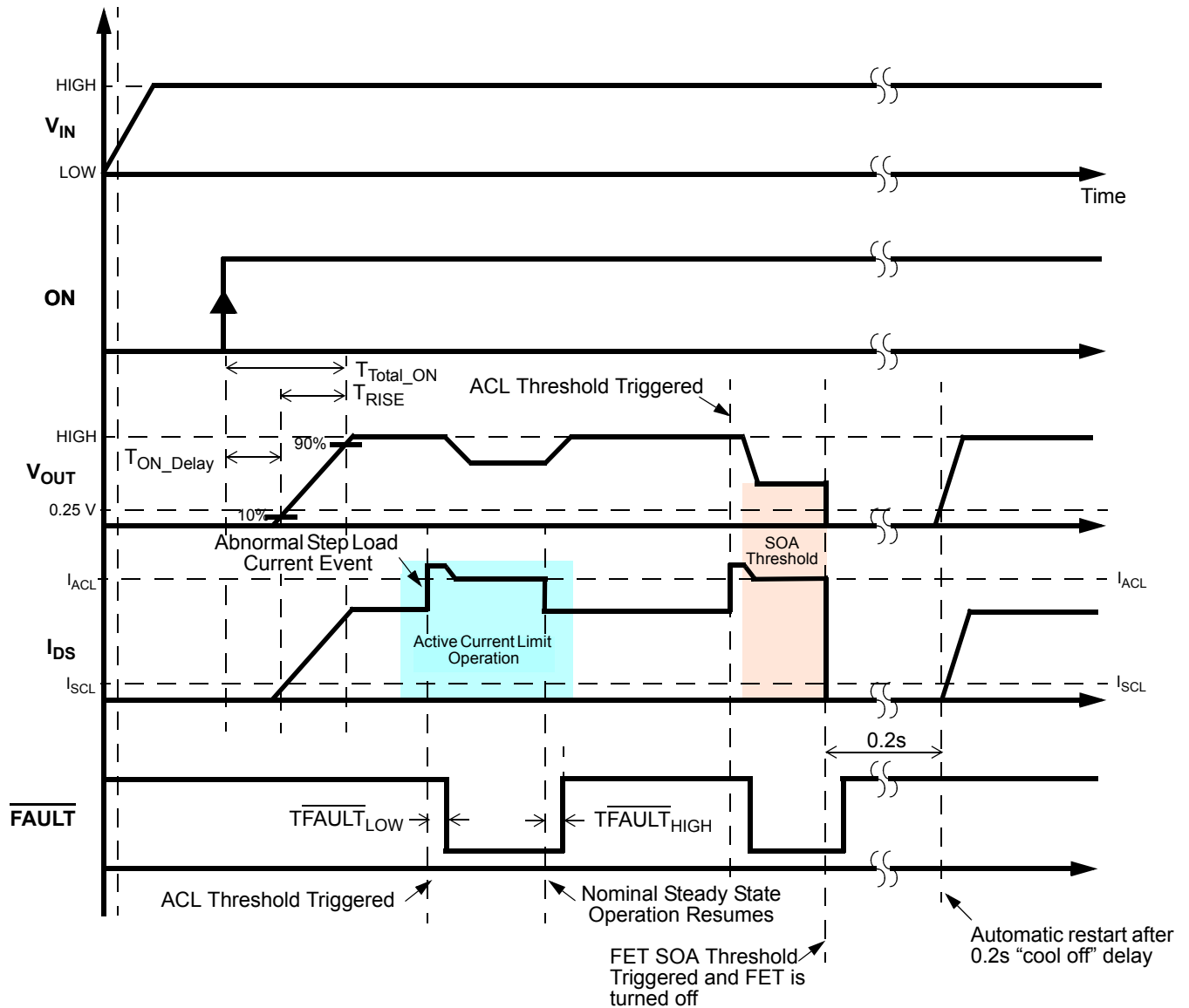


### Timing Diagram - Active Current Limit & Thermal Protection Operation





### Timing Diagram - Basic Operation including Active Current + Internal FET SOA Protection





### Applications Information

#### HFET1 Safe Operating Area Explained

Silego's HFET1 integrated power controllers incorporate a number of internal protection features that prevents them from damaging themselves or any other circuit or subcircuit downstream of them. One particular protection feature is their Safe Operation Area (SOA) protection. SOA protection is automatically activated under overpower and, in some cases, under overcurrent conditions. Overpower SOA is activated if package power dissipation exceeds an internal 5W threshold longer than 2.5 ms. HFET1 devices will quickly switch off (open circuit) upon overpower detection and automatically resume (close) nominal operation once overpower condition no longer exists.

One possible way to have an overpower condition trigger SOA protection is when HFET1 products are enabled into heavy output resistive loads and/or into large load capacitors. It is under these conditions to follow carefully the "Safe Start-up Loading" guidance in the Applications section of the datasheet. During an overcurrent condition, HFET1 devices will try to limit the output current to the level set by the external  $R_{SET}$  resistor. Limiting the output current, however, causes an increased voltage drop across the FET's channel because the FET's  $R_{DS_{ON}}$  increased as well. Since the FET's  $R_{DS_{ON}}$  is larger, package power dissipation also increases. If the resultant increase in package power dissipation is higher/equal than 5 W for longer than 2.5 ms, internal SOA protection will be triggered and the FET will open circuit (switch off). Every time SOA protection is triggered, all HFET1 devices will automatically attempt to resume nominal operation after 160 ms.

#### Safe Start-up Condition

SLG59H1013V has built-in protection to prevent over-heating during start-up into a heavy load. Overloading the  $V_{OUT}$  pin with a capacitor and a resistor may result in non-monotonic  $V_{OUT}$  ramping. In general, under light loading on  $V_{OUT}$ ,  $V_{OUT}$  ramping can be controlled with  $C_{SLEW}$  value. The following equation serves as a guide:

$$C_{SLEW} = \frac{T_{RAMP}}{V_{IN}} \times 4.9 \mu A \times \frac{20}{3}$$

where

$T_{RAMP}$  = Total ramping time for  $V_{OUT}$  to reach  $V_{IN}$

$V_{IN}$  = Input Voltage

$C_{SLEW}$  = Capacitor value for CAP pin

When capacitor and resistor loading on  $V_{OUT}$  during start up, the following tables will ensure  $V_{OUT}$  ramping is monotonic without triggering internal protection:

| Safe Start-up Loading for $V_{IN} = 24 \text{ V}$ (Monotonic Ramp) |                         |                        |                         |
|--------------------------------------------------------------------|-------------------------|------------------------|-------------------------|
| Slew Rate (V/ms)                                                   | $C_{SLEW}$ Control (nF) | $C_{LOAD}$ ( $\mu F$ ) | $R_{LOAD}$ ( $\Omega$ ) |
| 0.5                                                                | 66.7                    | 500                    | 80                      |
| 1.0                                                                | 33.3                    | 250                    | 80                      |
| 1.5                                                                | 22.2                    | 160                    | 80                      |
| 2.0                                                                | 16.7                    | 120                    | 80                      |
| 2.5                                                                | 13.3                    | 100                    | 80                      |



| Safe Start-up Loading for $V_{IN} = 12\text{ V}$ (Monotonic Ramp) |                         |                              |                         |
|-------------------------------------------------------------------|-------------------------|------------------------------|-------------------------|
| Slew Rate (V/ms)                                                  | $C_{SLEW}$ Control (nF) | $C_{LOAD}$ ( $\mu\text{F}$ ) | $R_{LOAD}$ ( $\Omega$ ) |
| 1                                                                 | 33.3                    | 500                          | 20                      |
| 2                                                                 | 16.7                    | 250                          | 20                      |
| 3                                                                 | 11.1                    | 160                          | 20                      |
| 4                                                                 | 8.3                     | 120                          | 20                      |
| 5                                                                 | 6.7                     | 100                          | 20                      |

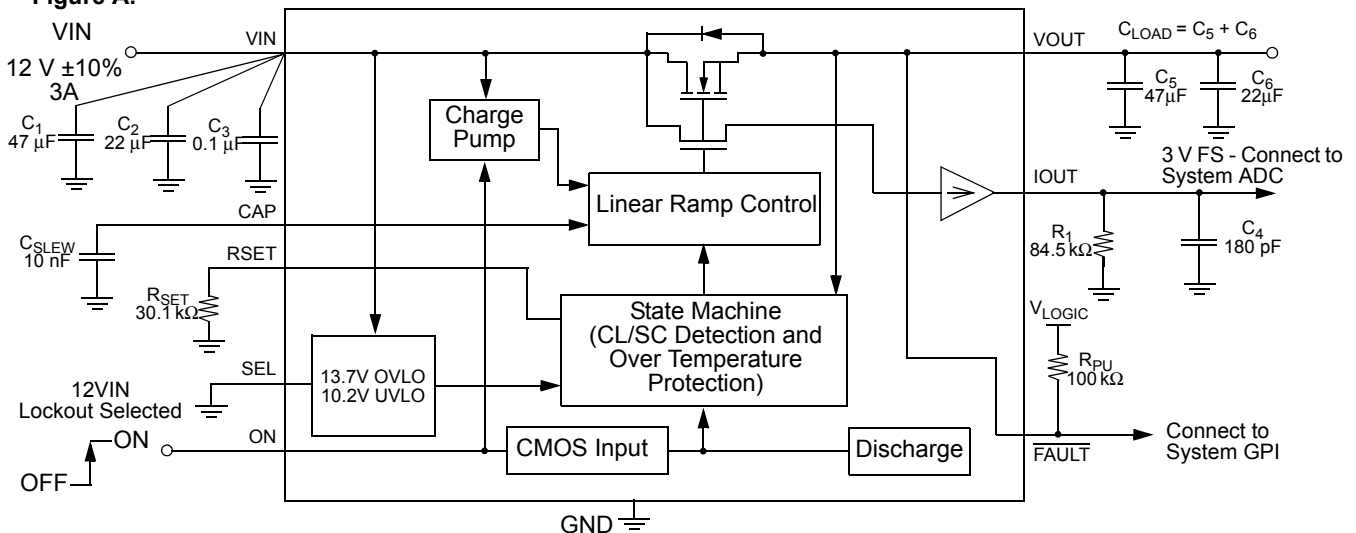
### Setting the SLG59H1013V's Active Current Limit

| $R_{SET}$ (k $\Omega$ ) | Active Current Limit (A) |
|-------------------------|--------------------------|
| 91                      | 1                        |
| 45                      | 2                        |
| 30                      | 3                        |
| 23.7                    | 4                        |

### Configuring the SLG59H1013V for 12VIN Lockout Applications

To configure the SLG59H1013V for conditioned  $12\text{ V} \pm 10\%$   $V_{IN}$  applications is simply a matter of connecting the SEL pin to GND as shown in *Figure A*. For other  $V_{IN}$  lockout window applications, please consult Silego for additional information.

**Figure A.**

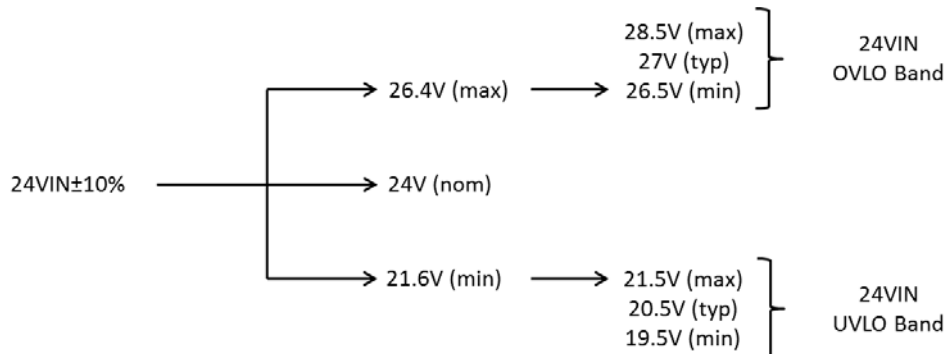




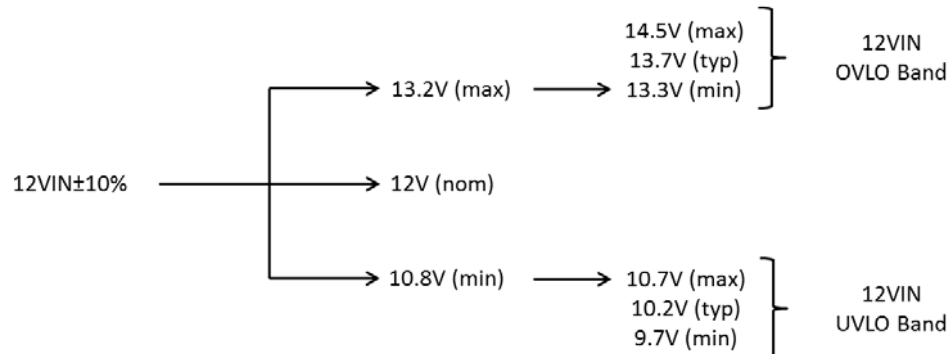
### 24VIN and 12VIN Lockout Window Thresholds

Shown in *Figure B* and *Figure C* are the two sets of  $V_{IN}$  overvoltage/undervoltage lockout windows – one for conditioned 24 V  $\pm 10\%$   $V_{IN}$  systems and the second for conditioned 12 V  $\pm 10\%$   $V_{IN}$  systems. The SLG59H1013V's lockout thresholds represent a  $\pm 5\%$  distribution around each respective typical voltage threshold. To avoid lockout threshold collision with nominal operation, the SLG59H1013V's  $V_{IN}$  (OV, min) and  $V_{IN}$  (UV, max) thresholds were set 0.1V correspondingly higher than the system's nominal  $V_{IN}(H)$  or lower than the system's  $V_{IN}(L)$  range.

**Figure B.**



**Figure C.**



### Power Dissipation

The junction temperature of the SLG59H1013V depends on different factors such as board layout, ambient temperature, and other environmental factors. The primary contributor to the increase in the junction temperature of the SLG59H1013V is the power dissipation of its power MOSFET. Its power dissipation and the junction temperature in nominal operating mode can be calculated using the following equations:

$$PD = RDS_{ON} \times I_{DS}^2$$

where:

PD = Power dissipation, in Watts (W)

$RDS_{ON}$  = Power MOSFET ON resistance, in Ohms ( $\Omega$ )

$I_{DS}$  = Output current, in Amps (A)

and

$$T_J = PD \times \theta_{JA} + T_A$$

where:

$T_J$  = Junction temperature, in Celsius degrees ( $^{\circ}C$ )

$\theta_{JA}$  = Package thermal resistance, in Celsius degrees per Watt ( $^{\circ}C/W$ )

$T_A$  = Ambient temperature, in Celsius degrees ( $^{\circ}C$ )



### Power Dissipation (continued)

In current-limit mode, the SLG59H1013V's power dissipation can be calculated by taking into account the voltage drop across the power switch ( $V_{IN} - V_{OUT}$ ) and the magnitude of the output current in current-limit mode ( $I_{ACL}$ ):

$$PD = (V_{IN} - V_{OUT}) \times I_{ACL} \text{ or}$$
$$PD = (V_{IN} - (R_{LOAD} \times I_{ACL})) \times I_{ACL}$$

where:

PD = Power dissipation, in Watts (W)

$V_{IN}$  = Input Voltage, in Volts (V)

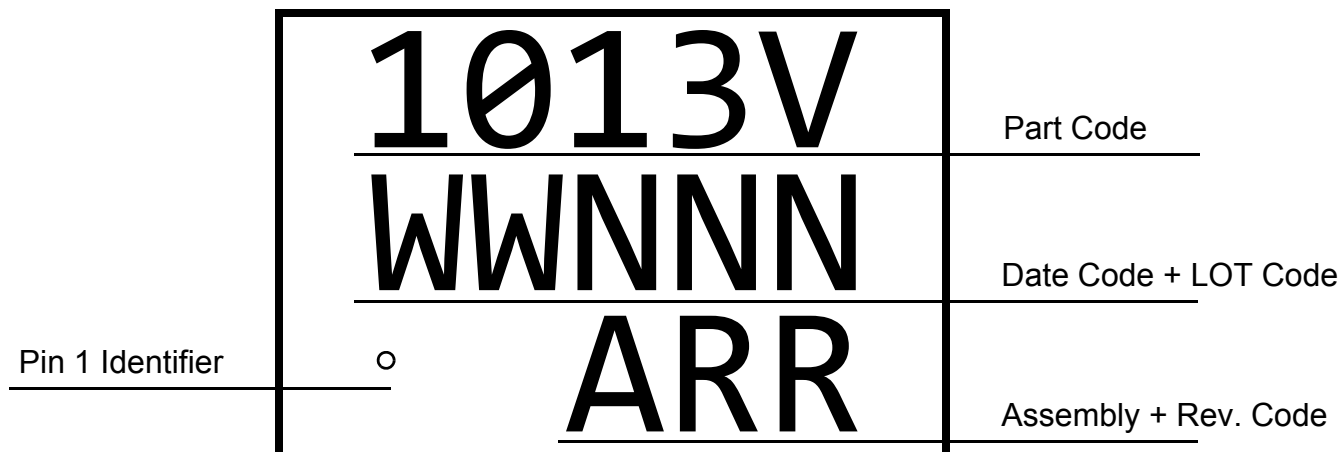
$R_{LOAD}$  = Load Resistance, in Ohms ( $\Omega$ )

$I_{ACL}$  = Output limited current, in Amps (A)

$V_{OUT} = R_{LOAD} \times I_{ACL}$



Package Top Marking System Definition



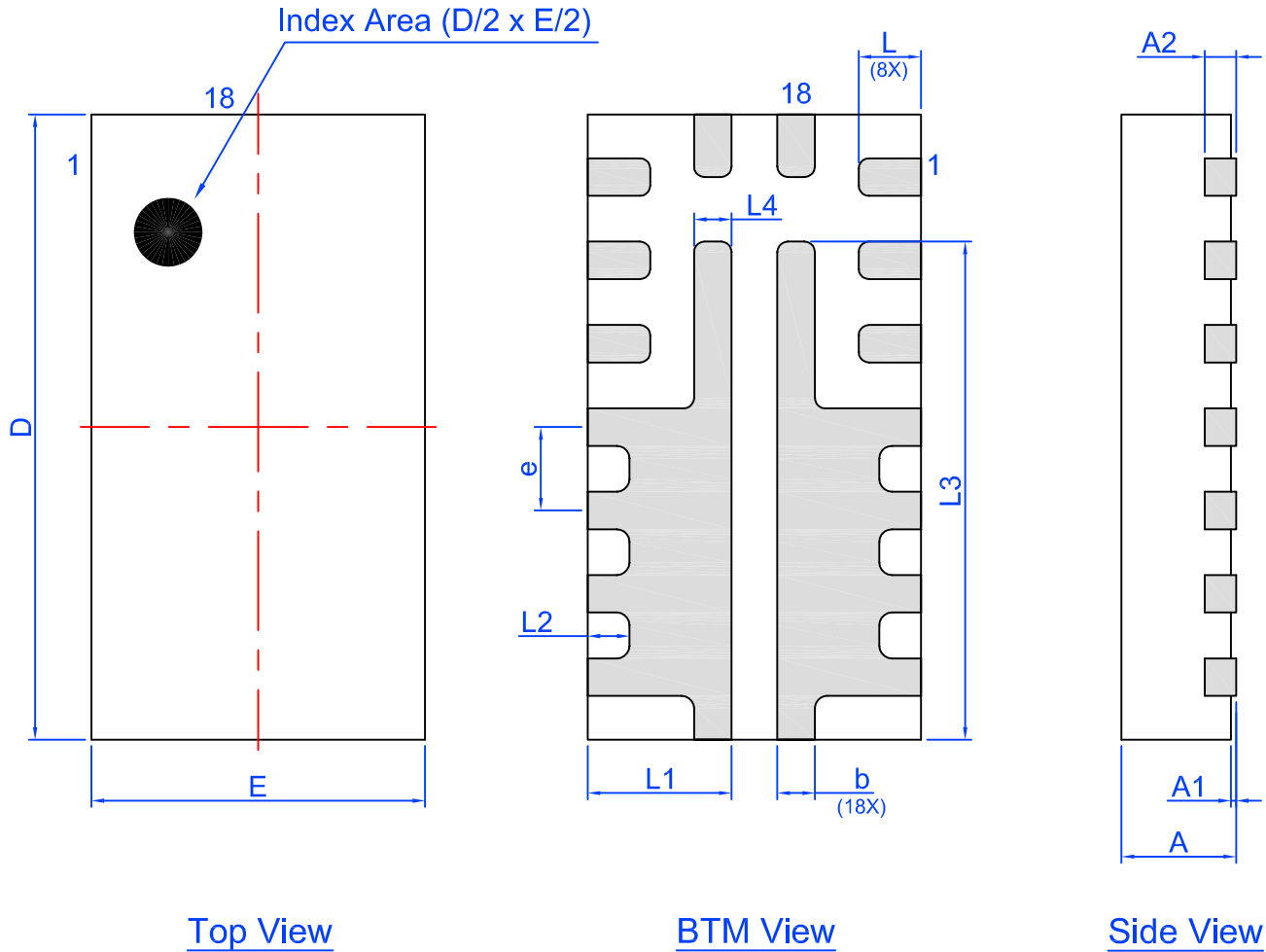
1013V - Part ID Field  
WW - Date Code Field<sup>1</sup>  
NNN - Lot Traceability Code Field<sup>1</sup>  
A - Assembly Site Code Field<sup>2</sup>  
RR - Part Revision Code Field<sup>2</sup>

Note 1: Each character in code field can be alphanumeric A-Z and 0-9  
Note 2: Character in code field can be alphabetic A-Z



### Package Drawing and Dimensions

18 Lead TQFN Package 1.6 x 3 mm (Fused Lead)  
JEDEC MO-220, Variation WCEE



Unit: mm

| Symbol | Min      | Nom. | Max  | Symbol | Min  | Nom. | Max  |
|--------|----------|------|------|--------|------|------|------|
| A      | 0.50     | 0.55 | 0.60 | D      | 2.95 | 3.00 | 3.05 |
| A1     | 0.005    | -    | 0.05 | E      | 1.55 | 1.60 | 1.65 |
| A2     | 0.10     | 0.15 | 0.20 | L      | 0.25 | 0.30 | 0.35 |
| b      | 0.13     | 0.18 | 0.23 | L1     | 0.64 | 0.69 | 0.74 |
| e      | 0.40 BSC |      |      | L2     | 0.15 | 0.20 | 0.25 |
| L3     | 2.34     | 2.39 | 2.44 | L4     | 0.13 | 0.18 | 0.23 |



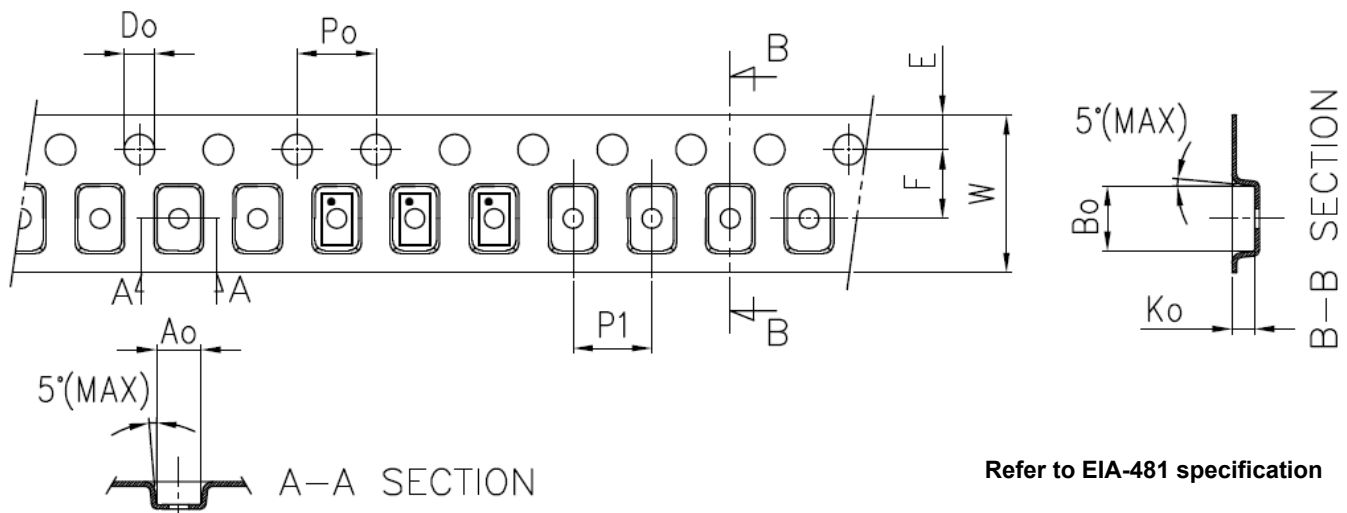


### Tape and Reel Specifications

| Package Type            | # of Pins | Nominal Package Size [mm] | Max Units |         | Reel & Hub Size [mm] | Leader (min) |             | Trailer (min) |             | Tape Width [mm] | Part Pitch [mm] |
|-------------------------|-----------|---------------------------|-----------|---------|----------------------|--------------|-------------|---------------|-------------|-----------------|-----------------|
|                         |           |                           | per Reel  | per Box |                      | Pockets      | Length [mm] | Pockets       | Length [mm] |                 |                 |
| STQFN 18L 0.4P FC Green | 18        | 1.6 x 3 x 0.55            | 3,000     | 3,000   | 178 / 60             | 100          | 400         | 100           | 400         | 8               | 4               |

### Carrier Tape Drawing and Dimensions

| Package Type            | Pocket BTM Length | Pocket BTM Width | Pocket Depth | Index Hole Pitch | Pocket Pitch | Index Hole Diameter | Index Hole to Tape Edge | Index Hole to Pocket Center | Tape Width |
|-------------------------|-------------------|------------------|--------------|------------------|--------------|---------------------|-------------------------|-----------------------------|------------|
|                         | A0                | B0               | K0           | P0               | P1           | D0                  | E                       | F                           | W          |
| STQFN 18L 0.4P FC Green | 1.78              | 3.18             | 0.76         | 4                | 4            | 1.5                 | 1.75                    | 3.5                         | 8          |



### Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 2.64 mm<sup>3</sup> (nominal). More information can be found at [www.jedec.org](http://www.jedec.org).



# SILEGO

## SLG59H1013V

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### Revision History

| Date      | Version | Change             |
|-----------|---------|--------------------|
| 2/24/2017 | 1.00    | Production Release |

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